

# 2SD0958 (2SD958)

Silicon NPN epitaxial planer type

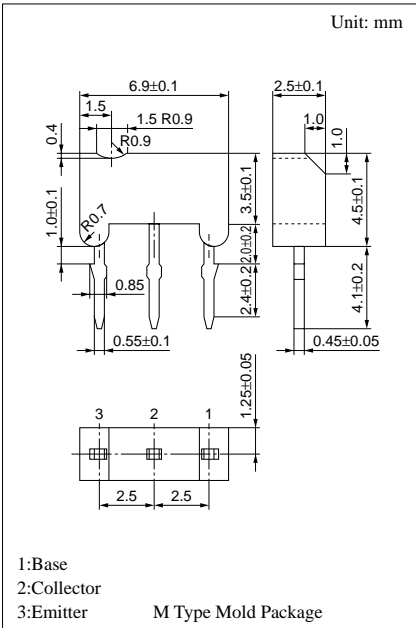
For high breakdown voltage and low-noise amplification  
Complementary to 2SB0788 (2SB788)

## Features

- High collector to emitter voltage  $V_{CEO}$ .
- Low noise voltage NV.
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

## Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	120	V
Collector to emitter voltage	$V_{CEO}$	120	V
Emitter to base voltage	$V_{EBO}$	7	V
Peak collector current	$I_{CP}$	50	mA
Collector current	$I_C$	20	mA
Collector power dissipation	$P_C$	400	mW
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	-55 ~ +150	°C



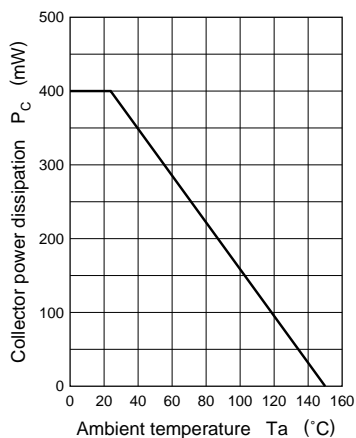
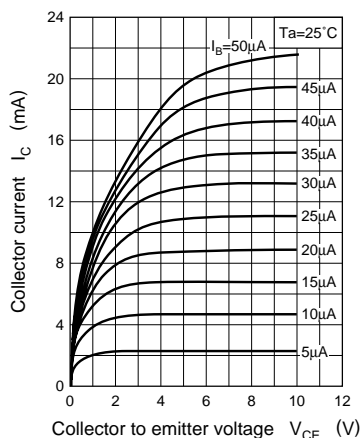
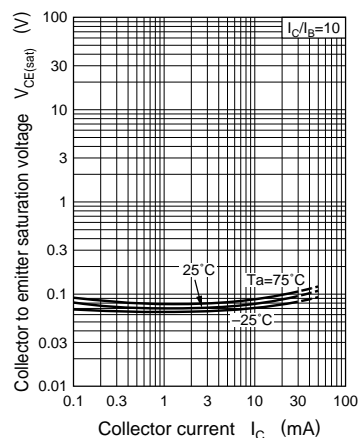
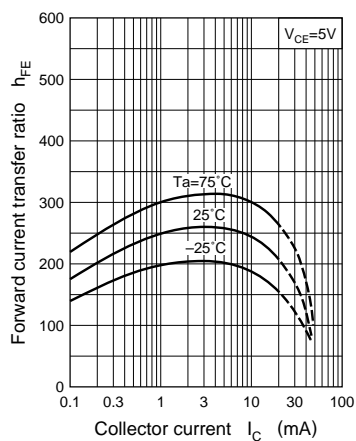
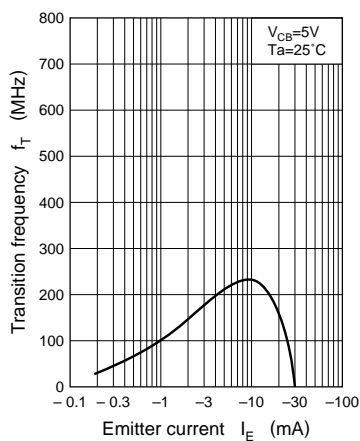
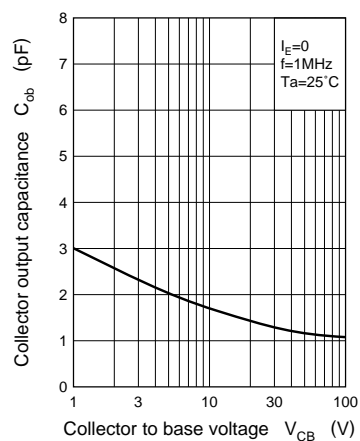
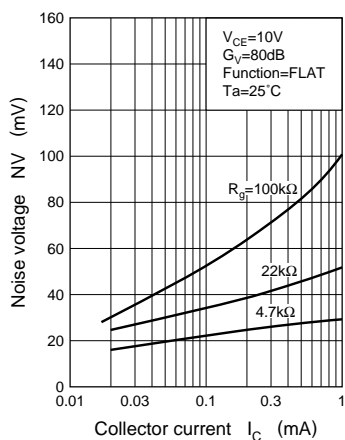
## Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 50V, I_E = 0$			100	nA
Collector cutoff current	$I_{CEO}$	$V_{CE} = 50V, I_B = 0$			1	μA
Collector to base voltage	$V_{CBO}$	$I_C = 10\mu A, I_E = 0$	120			V
Collector to emitter voltage	$V_{CEO}$	$I_C = 1mA, I_B = 0$	120			V
Emitter to base voltage	$V_{EBO}$	$I_E = 10\mu A, I_C = 0$	7			V
Forward current transfer ratio	$h_{FE}^*$	$V_{CE} = 5V, I_C = 2mA$	180		700	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 20mA, I_B = 2mA$			0.6	V
Transition frequency	$f_T$	$V_{CB} = 5V, I_E = -2mA, f = 200MHz$		200		MHz
Noise voltage	NV	$V_{CE} = 40V, I_C = 2mA, G_V = 80dB$ $R_g = 100k\Omega, \text{Function} = \text{FLAT}$			150	mV

\* $h_{FE}$  Rank classification

Rank	R	S	T
$h_{FE}$	180 ~ 360	260 ~ 520	360 ~ 700

Note.) The Part number in the Parenthesis shows conventional part number.

$P_C - T_a$  $I_C - V_{CE}$  $V_{CE(sat)} - I_C$  $h_{FE} - I_C$  $f_T - I_E$  $C_{ob} - V_{CB}$  $NV - I_C$ 

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